

SF1133A

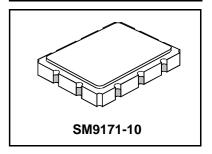
- Designed for GSM BTS Receiver IF Applications
- Compatible with National Semiconductor Chip Set
- Very Flexible Impedance Matching
- Unbalanced or Balanced Input or Output
- Complies with Directive 2002/95/EC (RoHS)



Absolute Maximum Ratings

| Rating | Value | Units |
|---|----------------|-------|
| Maximum Incident Power in Passband | +15 | dBm |
| Max. DC voltage between any 2 terminals | 30 | VDC |
| Storage Temperature Range | -40 to +85 | °C |
| Suitable for lead-free soldering - Max. Soldering Profile | 260°C for 30 s | |

246 MHz SAW Filter



Electrical Characteristics

| Characteristic | | | Notes | Min | Тур | Max | Units |
|-----------------------------|---|-----------------|---------|------|---------|-----|-------------------|
| Nominal Center Frequency | | f _C | 1 | | 246.000 | | MHz |
| Passband | Insertion Loss at fc | IL | 1 | | | 7.0 | dB |
| | 1 db Passband | BW ₁ | | ±100 | | | kHz |
| | Amplitude Ripple over fc±100 kHz | | 1, 2 | | | 1.0 | dB _{P-P} |
| | Group Delay Variation over fc ±100 kHz | GDV | | | | 500 | ns _{P-P} |
| Rejection | fc-800 to fc-600 and fc+600 to fc+800 kHz | | | 20 | | | |
| | fc-30 MHz to fc-800 kHz | | | 30 | | | |
| | fc+800 kHz to fc+17 MHz | | 1, 2, 3 | 30 | | | dB |
| | fc-80 MHz to fc-30 MHz | | | 35 | | | |
| | fc+17 Mhz to fc+80 MHz | | | 35 | | | |
| Operating Temperature Range | | T _A | 1 | -35 | | +85 | °C |

| Impedance Matching to 50 Ω Unbalanced | External L-C |
|--|---|
| Impedance Matching to 200 Ω Balanced | External L-C |
| Case Style | SMP9171-10 9.1 x 7.1 mm Nominal Footprint |
| Lid Symbolization (YY = year, WW = week) | RFM SF1133A YYWW |

Notes

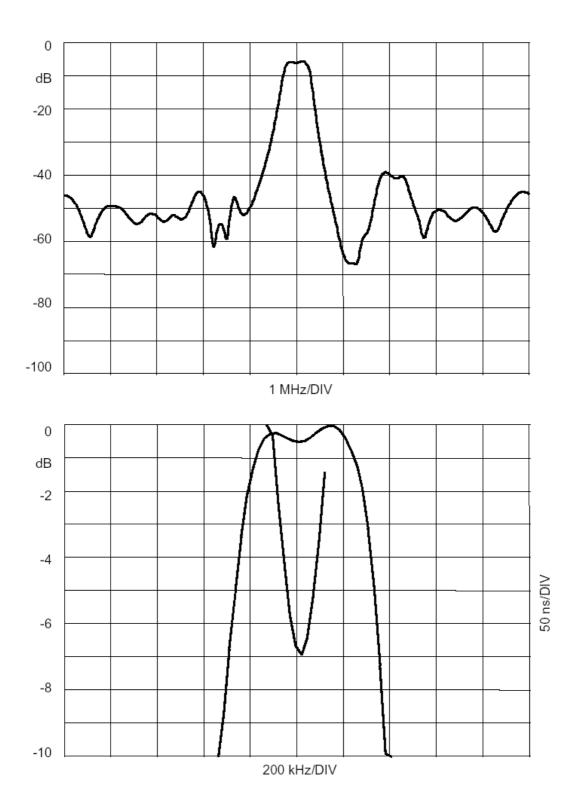
- 1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- 2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband.
 Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 5. The design, manufacturing process, and specifications of this filter are subject to change.
- Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- 7. US and international patents may apply.
- 8. Electrostatic Sensitive Device. Observe precautions for handling.



Electrical Connections

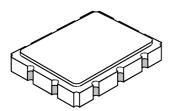
| Connection | Terminals |
|-------------------|------------|
| Port 1 Hot | 10 |
| Port 1 Gnd Return | 1 |
| Port 2 Hot | 5 |
| Port 2 Gnd Return | 6 |
| Case Ground | All others |

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SM9171-10 Case

10-Terminal Ceramic Surface-Mount Case 9.1 x 7.1 mm Nominal Footprint



| Case Dimensions | | | | | | |
|-----------------|------|------|------|--------|-------|-------|
| Dimension | mm | | | Inches | | |
| Dimension | Min | Nom | Max | Min | Nom | Max |
| Α | 8.86 | 9.09 | 9.40 | 0.349 | 0.358 | 0.370 |
| В | 6.88 | 7.11 | 7.40 | 0.271 | 0.280 | 0.291 |
| С | | 1.91 | 2.00 | | 0.075 | 0.079 |
| D | | 0.99 | | | 0.039 | |
| E | | 0.79 | | | 0.031 | |
| Н | | 1.0 | | | 0.039 | |
| Р | | 2.54 | | | 0.100 | |

| Materials | | | | |
|---------------------------|---|--|--|--|
| Solder Pad Termination | Au plating 30 - 60 μinches (76.2-152 μm) over 80- 200 μinches (203-508 μm) Ni. | | | |
| Lid | Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick | | | |
| Body | Al ₂ O ₃ Ceramic | | | |
| Pb Free | | | | |

| Electrical Connections | | | | |
|------------------------|------------------|------------------|--|--|
| | Connection | Terminals | | |
| Port 1 | Input or Return | 6 | | |
| | Return or Input | 5 | | |
| Port 2 | Output or Return | 1 | | |
| | Return or Output | 10 | | |
| | Ground | All others | | |
| Single Ended Operation | | Return is ground | | |
| Differential Operation | | Return is hot | | |

